



PATENTS

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**Applicant(s):** Stephen L. Buchwalter, et al.

**Examiner:** Khiem D. Nguyen

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**Docket:** YOR920000745US1 (14029)

**For:** BILAYER WAFER-LEVEL  
UNDERFILL

**Dated:** June 30, 2003

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**RESPONSE UNDER 37 C.F.R. §1.111**

Sir:

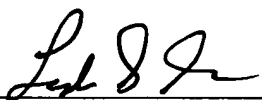
In response to the Office Action dated March 31, 2003, applicants submit the following amendments and remarks for entry of record in the above-identified patent application.

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**CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)**

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents, Alexandria, VA 22313-1450 on June 30, 2003.

Dated: June 30, 2003

  
Leslie S. Szivos, Ph.D.